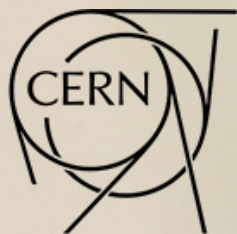


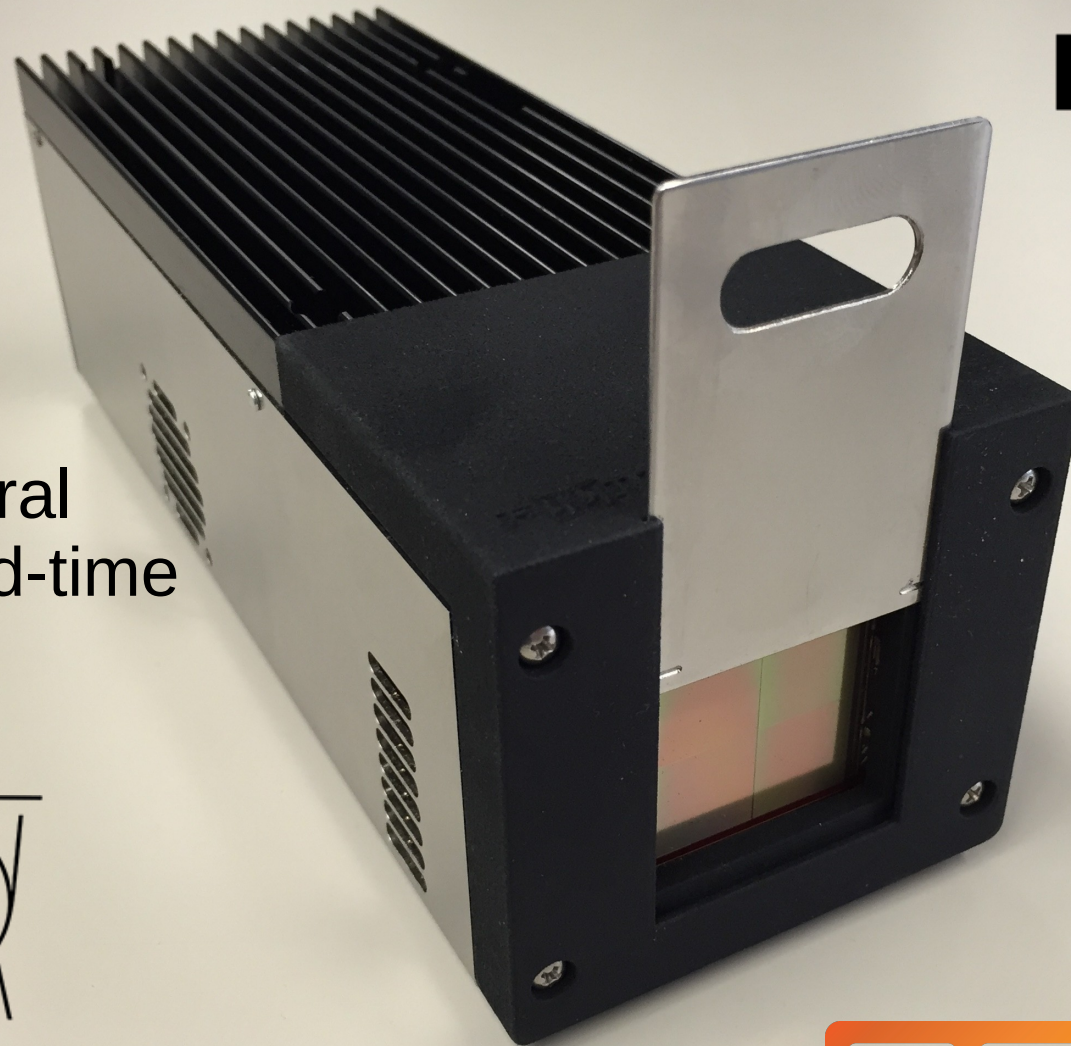
Medipix3RX



Spectral  
Zero dead-time



*technology*



AMSTERDAM  
SCIENTIFIC  
INSTRUMENTS

# High Sensitivity Mammography with a new generation of silicon pixel sensors



AMSTERDAM  
SCIENTIFIC  
INSTRUMENTS

Fast readout (SPIDR),  
mechanics and software.



**Universiteit Utrecht**

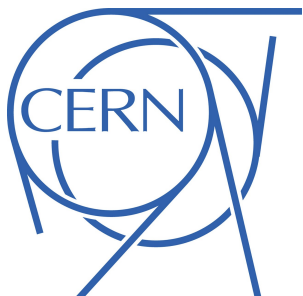
A. Mischke

Contact with radiology group  
and Physicians. Test on a  
working Mammography setup.



**UMC Utrecht**

H. de Jong



Chip design and test-beam.

Image courtesy  UMC Utrecht



1) X-Ray source

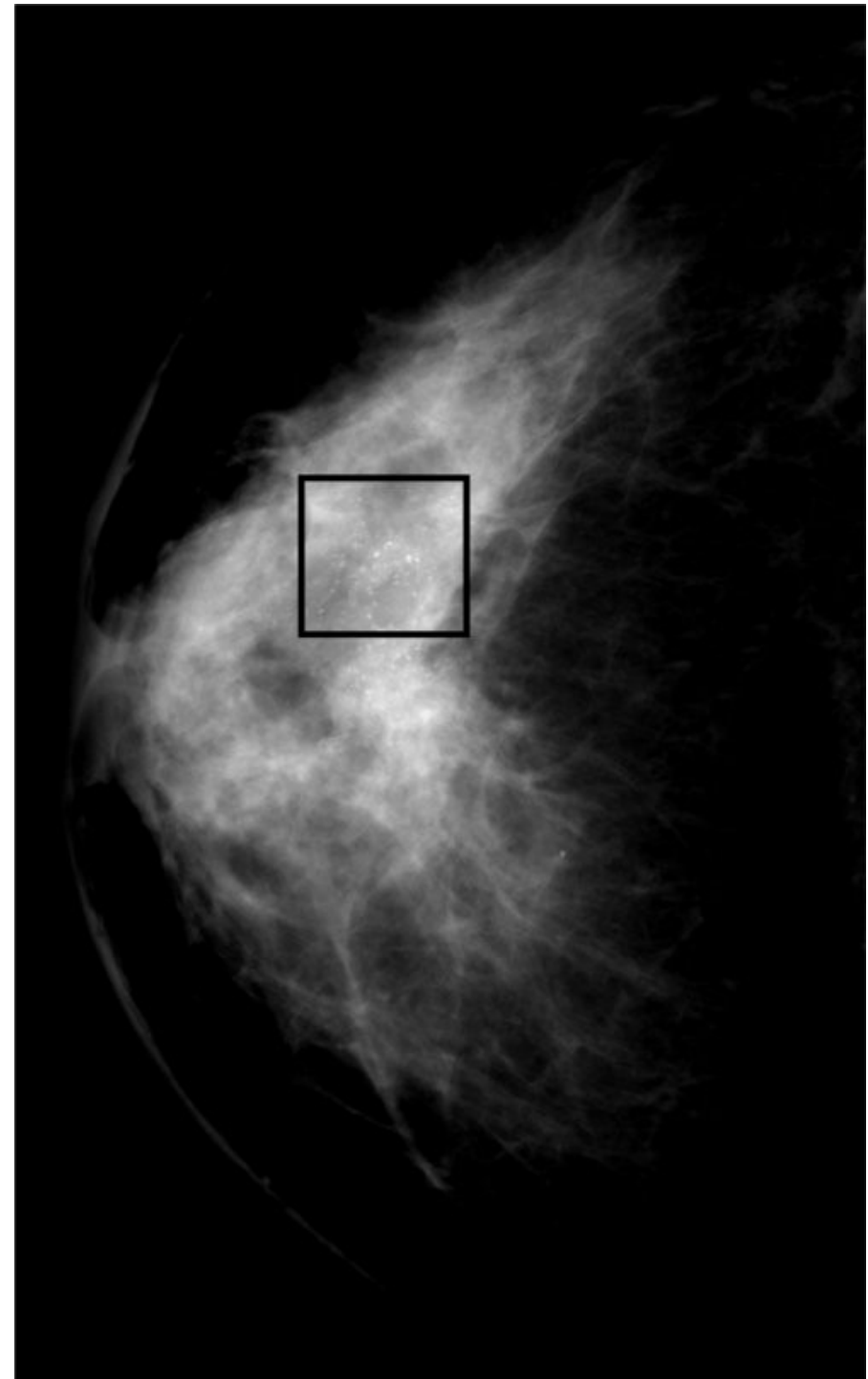
2) Detector

Mammography

3) Object

Human breast

Phantom



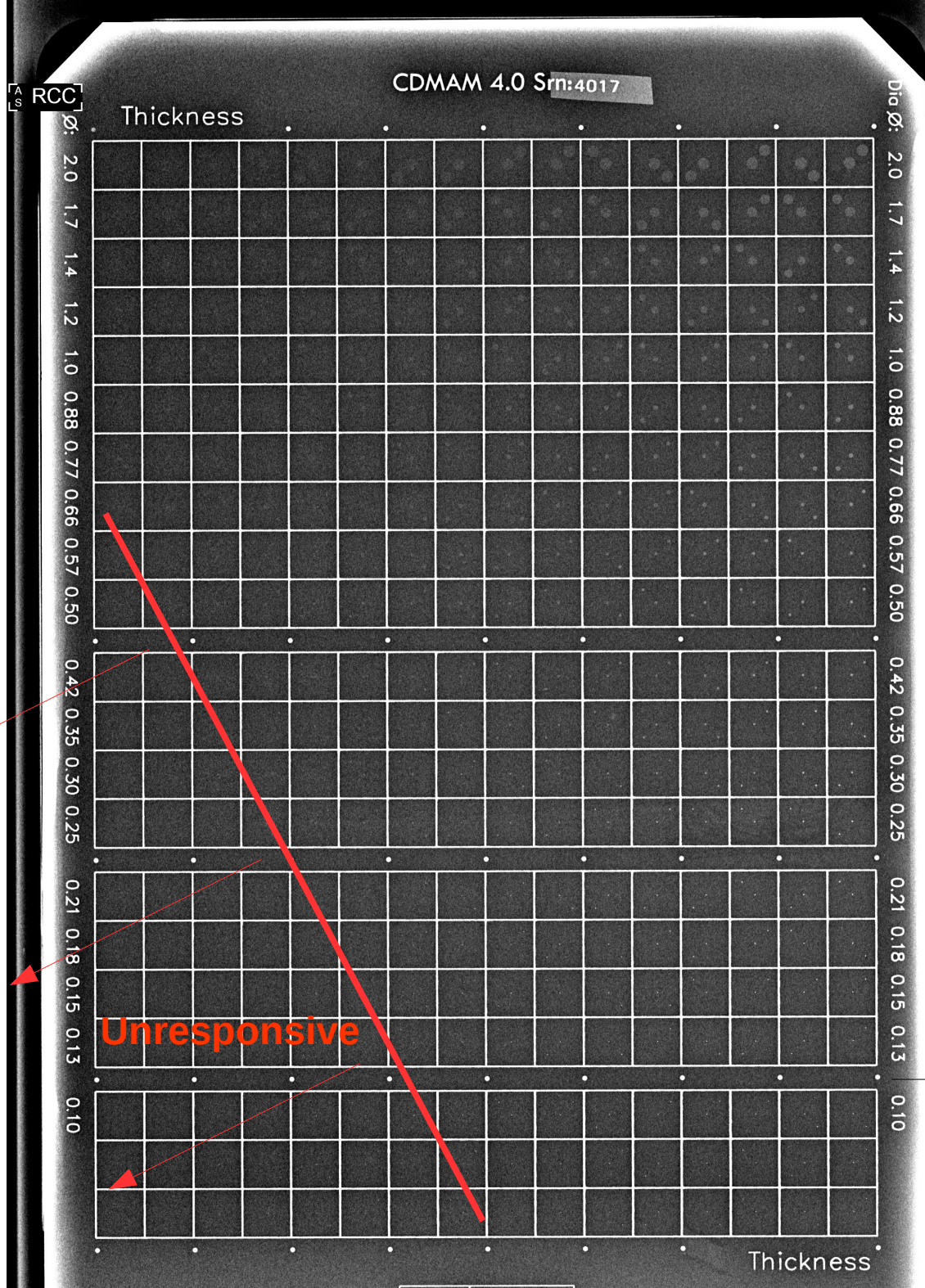
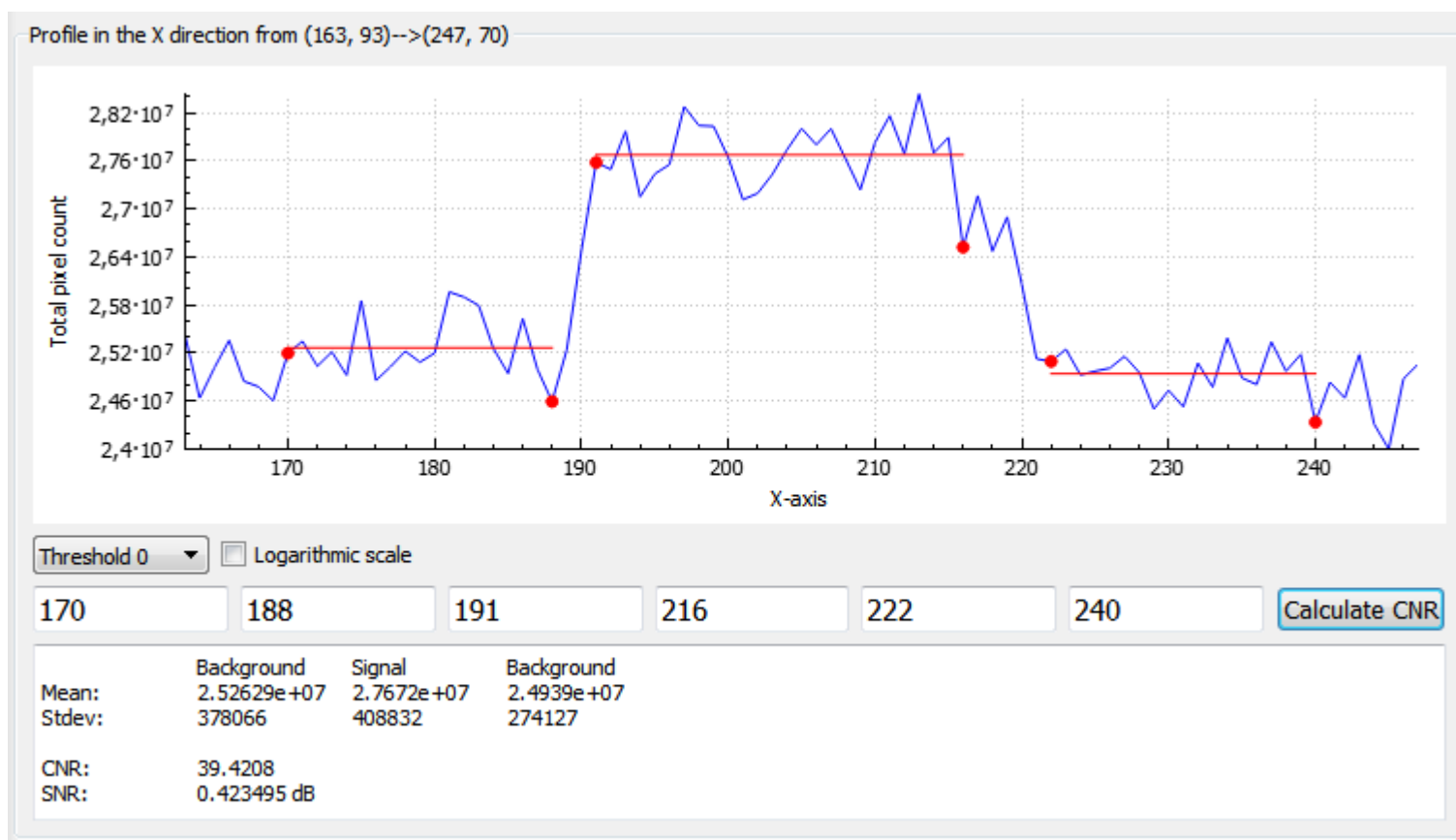
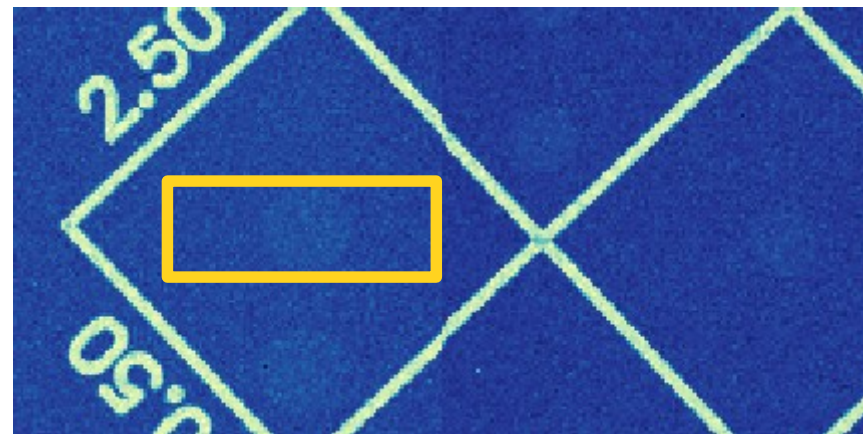
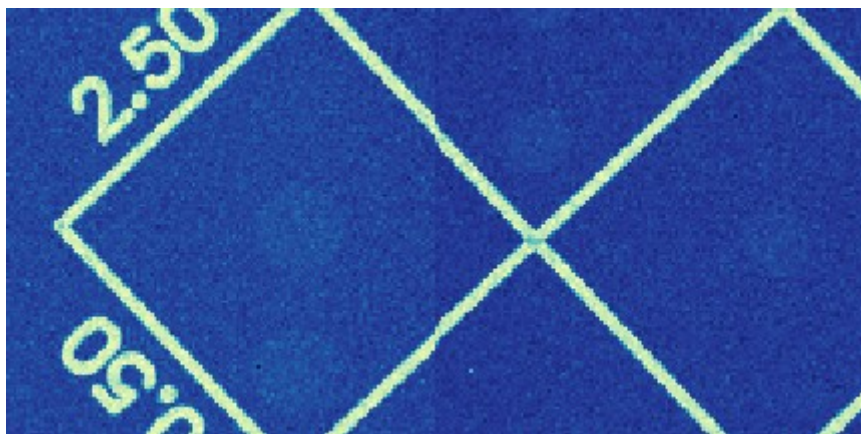


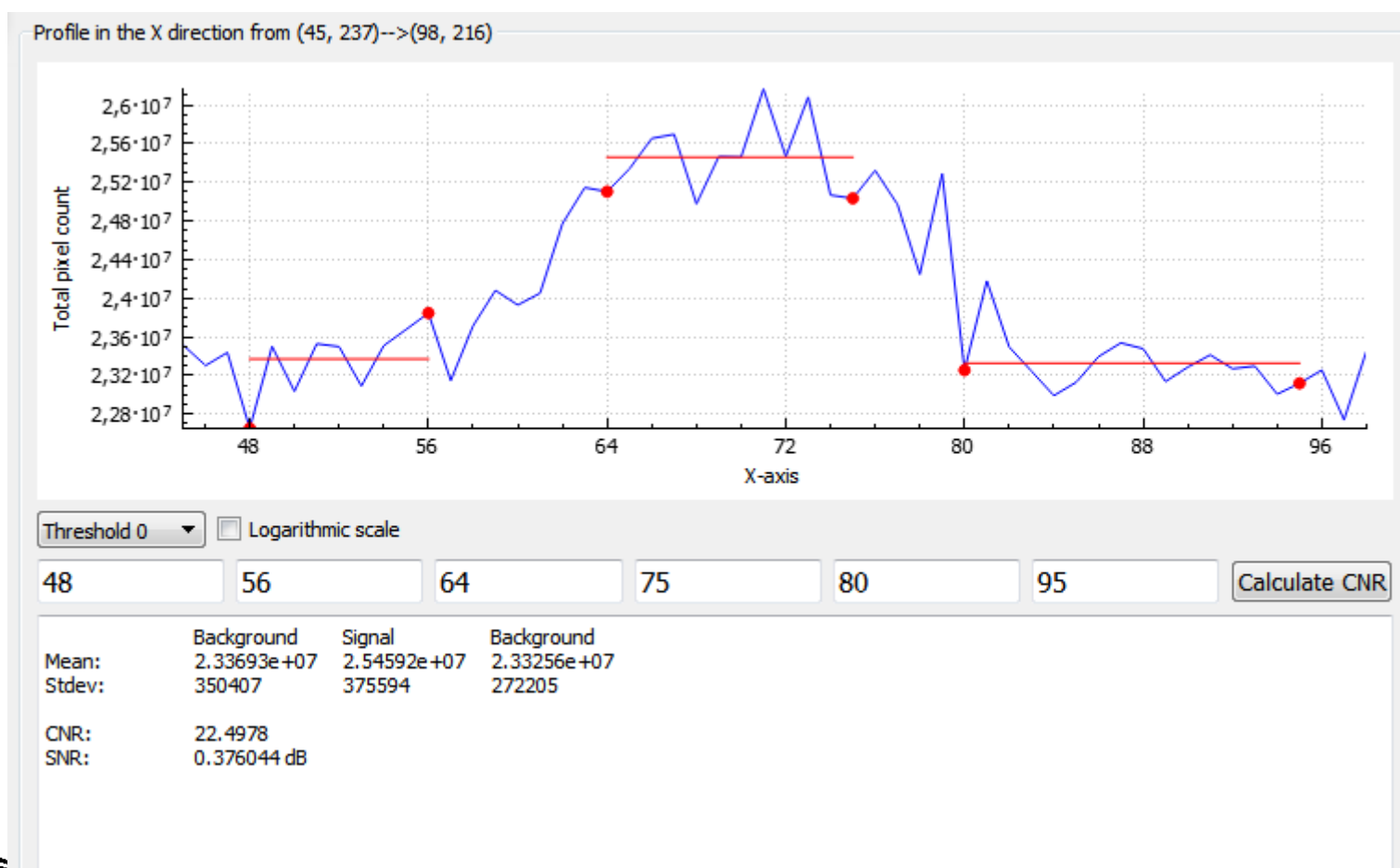
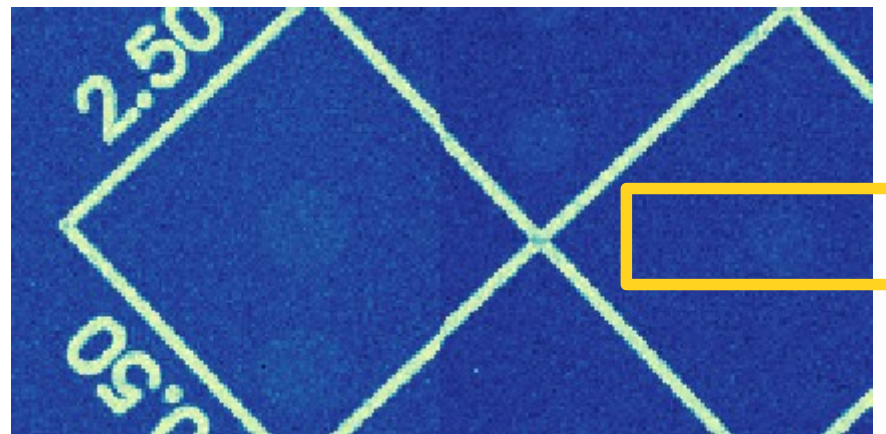
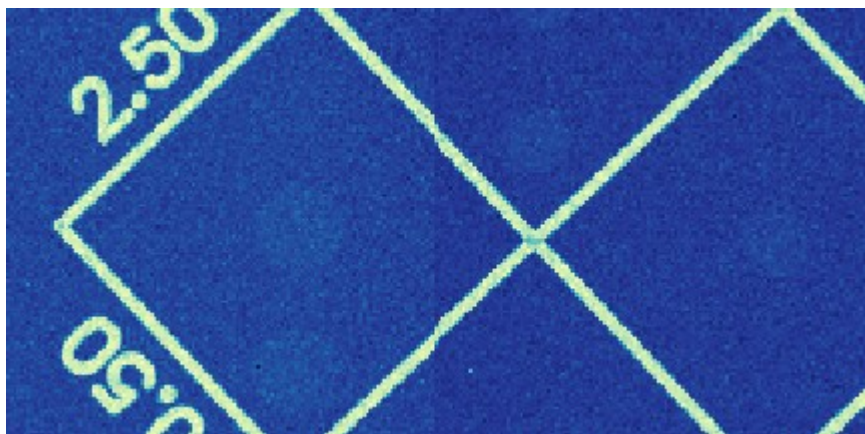
Image taken @ UMC with the mammographer

# Rose criteria - CNR



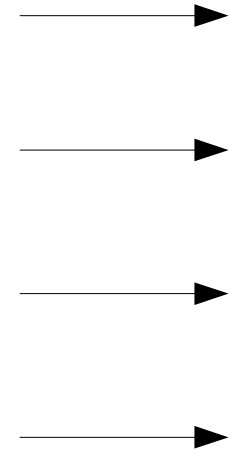
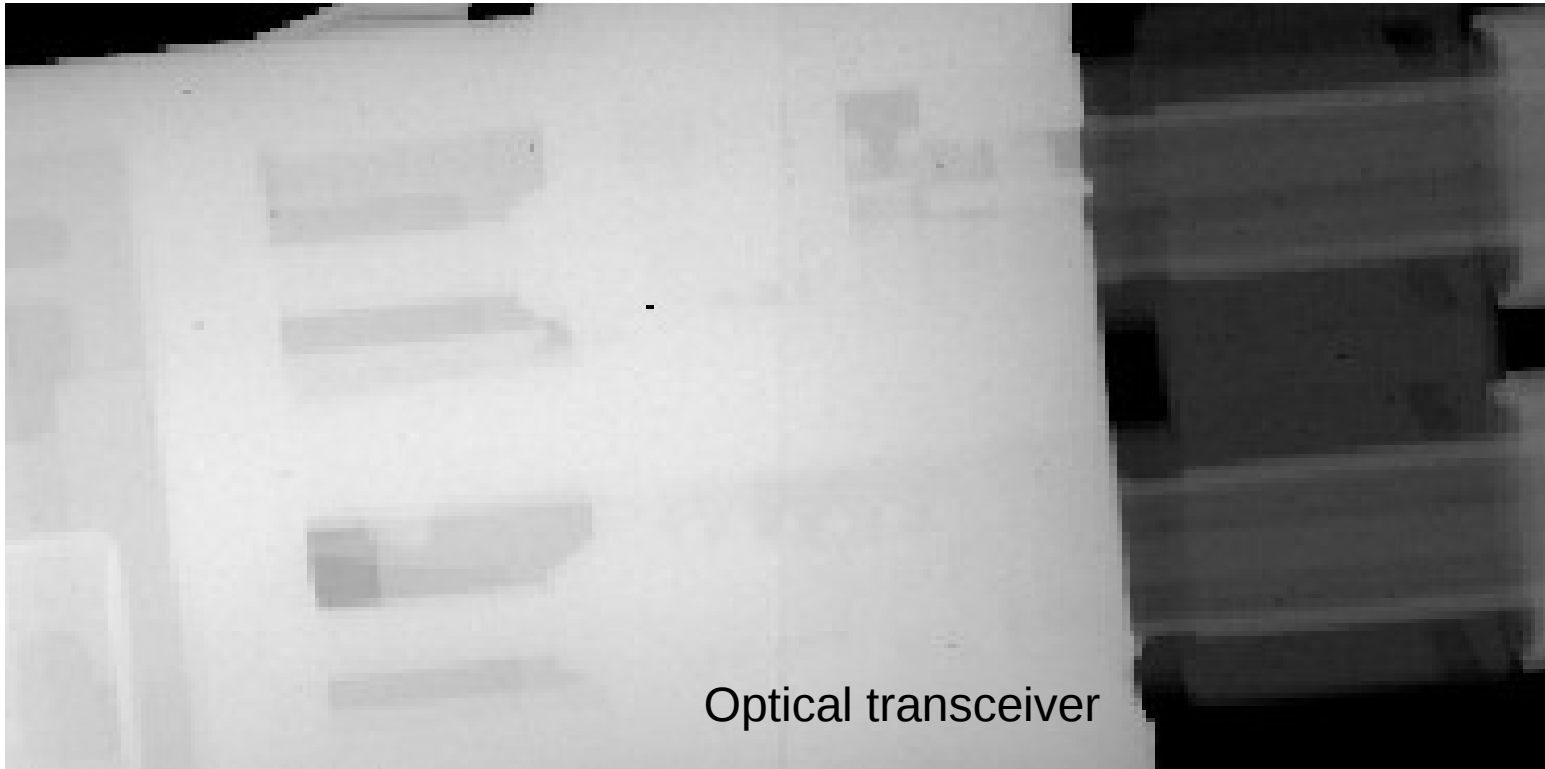
Constrat  
Noise  
Ratio (CNR)  
**CNR: 39.4**

# Rose criteria - CNR



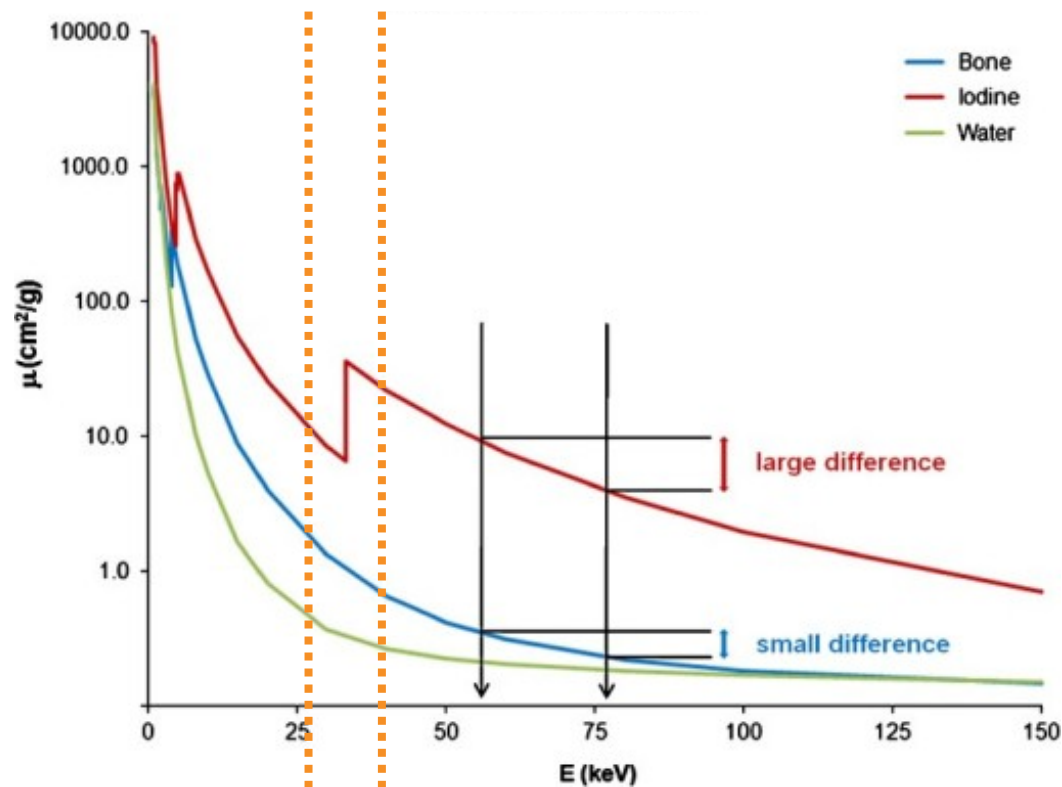
Constrat  
Noise  
Ratio (CNR)  
**CNR: 22.5**

## Guided Color reconstruction Vs. conventional X-ray



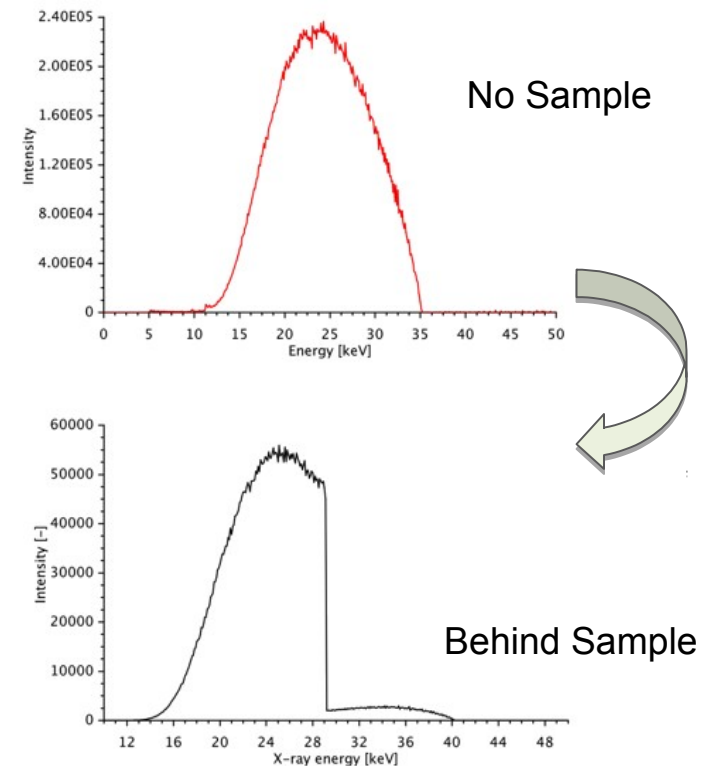
**Materials ?**

# Resolving material using k-edges



X-ray Attenuation Curves

<http://www.xrayphysics.com/attenuation.html>



Camera Signal

**A series of images can be taken with varying energy thresholds.**

**Different materials will have different combination of signal level at the thresholds.**



## Material-resolved reconstruction – NO edges

### Attenuation coeff reco

Attenuation  $I/I_0 = \exp(-\mu t)$

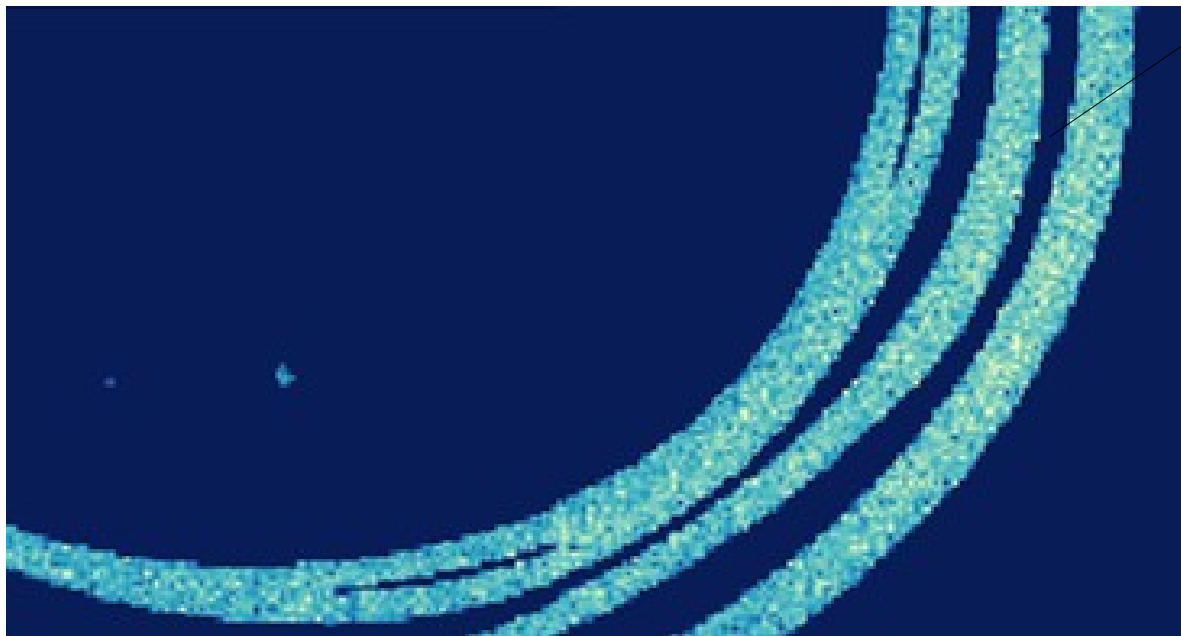
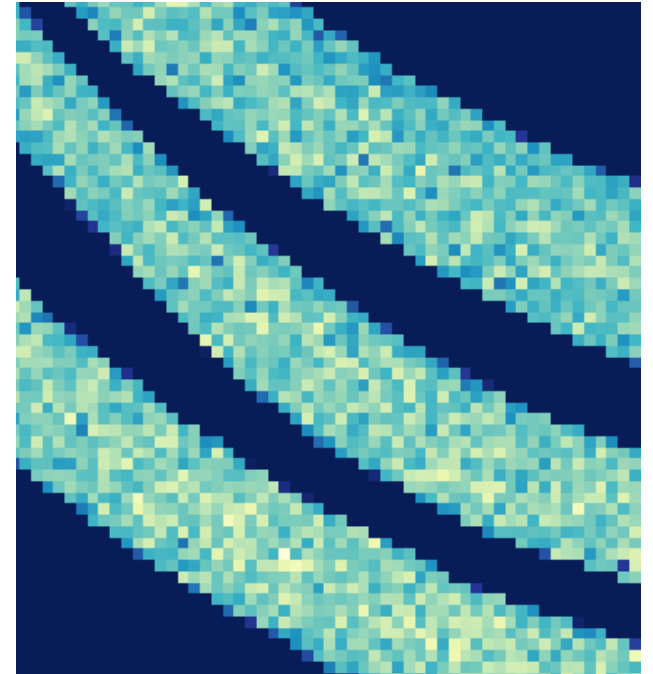
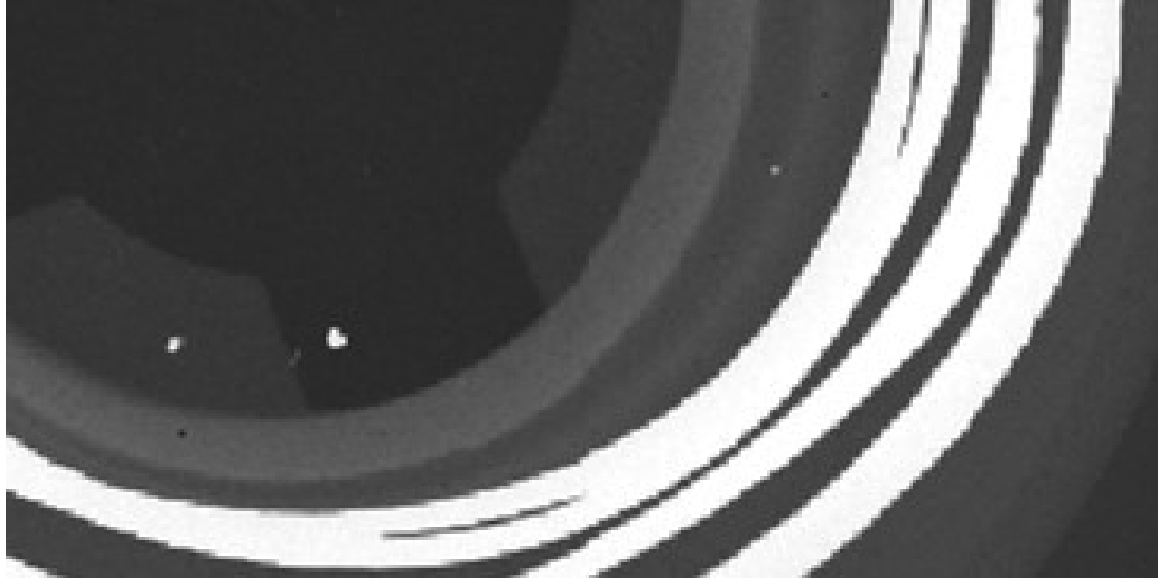
Taking  $-\log(I/I_0) = \lambda$

$$\lambda = \mu t.$$

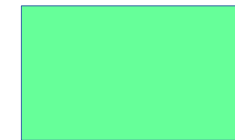
$$\begin{array}{ccc}
 & & \text{materials} \\
 & \xrightarrow{\hspace{10em}} & \\
 \begin{pmatrix} \lambda_0 \\ \vdots \\ \lambda_{N_E} \end{pmatrix} & = & \begin{pmatrix} \mu_0^0 & \cdots & \mu_0^{N_M} \\ \vdots & \ddots & \vdots \\ \mu_{N_E}^0 & \cdots & \mu_{N_E}^{N_M} \end{pmatrix} \begin{pmatrix} t^0 \\ \vdots \\ t^{N_M} \end{pmatrix} \\
 \downarrow & & \downarrow \\
 \text{energies} & & \text{thicknesses} \\
 & \vec{\lambda} = \mu \vec{t}. & 
 \end{array}$$

# Planar Color reconstruction Making the invisible visible

Conventional X-ray can not resolve entangled material structure. **Color X-ray can !**

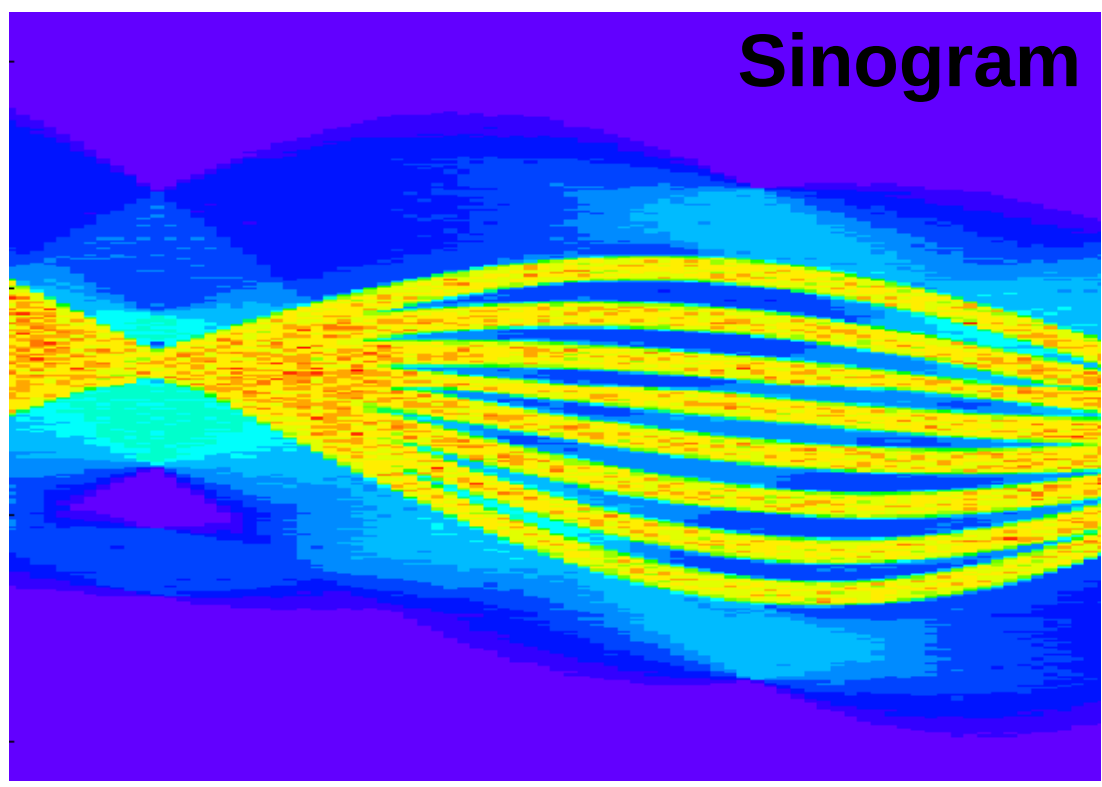
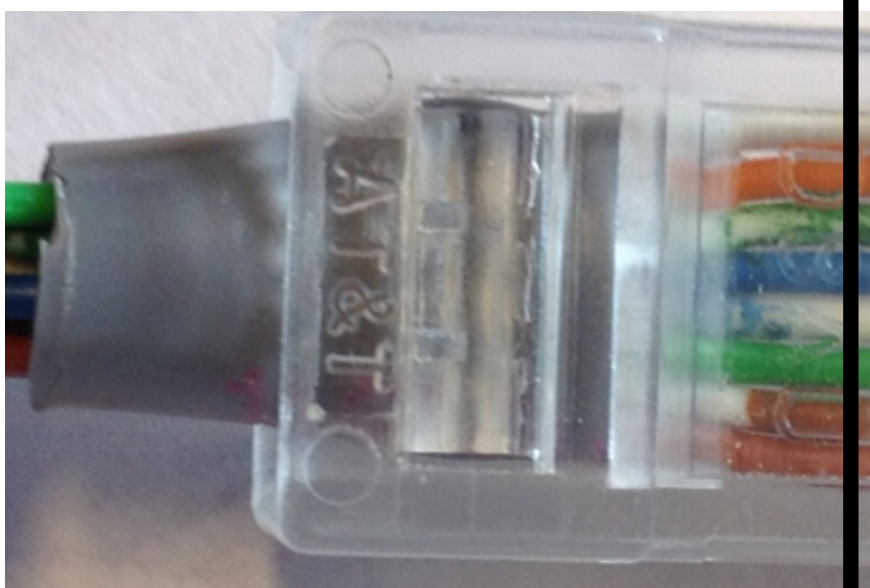


**Al 99% C.L.**

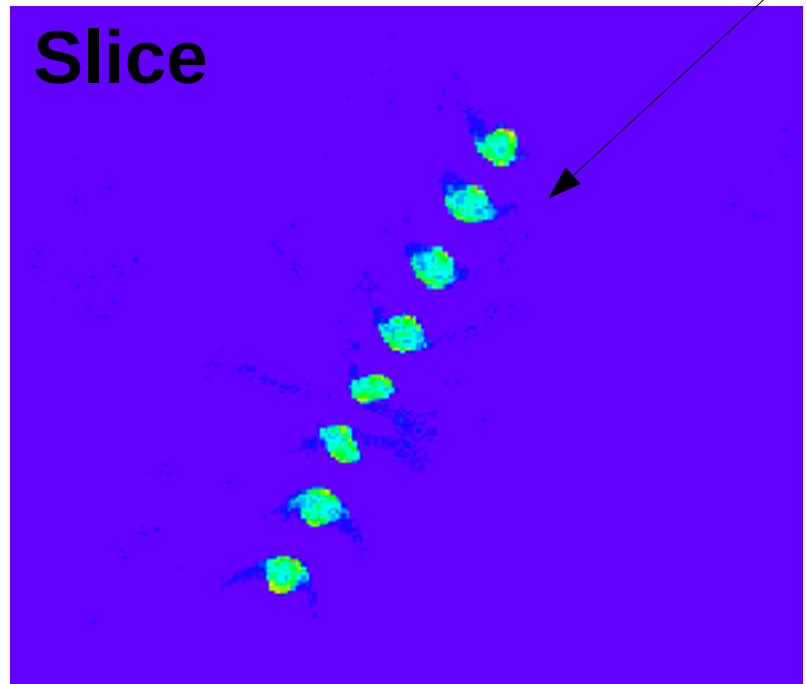


**Cu 99% C.L.**

CT reconstruction



angle



Multi-threshold

Fast material ID

Charge Summing Mode

Improves energy resolution

Programmable gain (4)

Enhances work energy range

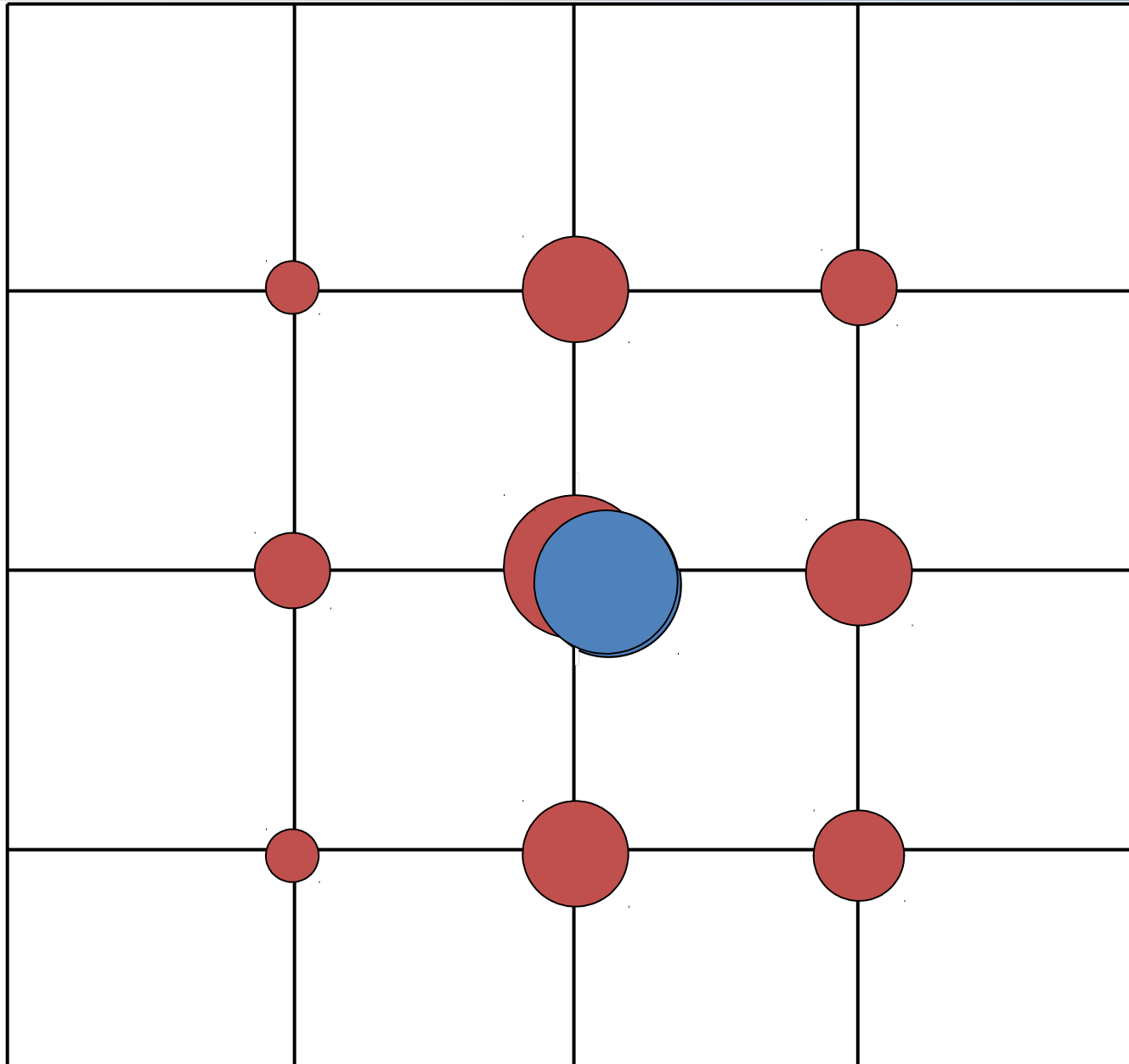
THL(E) calibration linear

Reliable calibration

### Pixel readout chip specifications

Pixels .....	512 x 512 / 256 x 256
Pixel size .....	55 $\mu\text{m}$ x 55 $\mu\text{m}$ (Fine Pitch Mode)
.....	110 $\mu\text{m}$ x 110 $\mu\text{m}$ (Spectroscopic Mode)
Technology .....	0.13 $\mu\text{m}$ CMOS
Input polarity .....	both electrons and holes
Minimum energy threshold .....	~1.8keV or ~500e <sup>-</sup>
Energy thresholds .....	8
Peaking time .....	120 ns

# The algorithm for charge reconstruction and hit allocation: Charge Summing Mode



- 1. TH<sub>0</sub> is applied to the local signal*
- 2. Arbitration circuitry identifies the pixel with largest charge and suppresses the pixels with lower signal*
- 3. In parallel, the charge has been reconstructed in the analog summing circuits*
- 4. The pixel with highest charge checks the adjacent summing circuits to see if at least one of them exceeds TH<sub>1</sub>*

**CONFIDENTIAL**

***Advantage of small pixels without disadvantage of charge sharing***

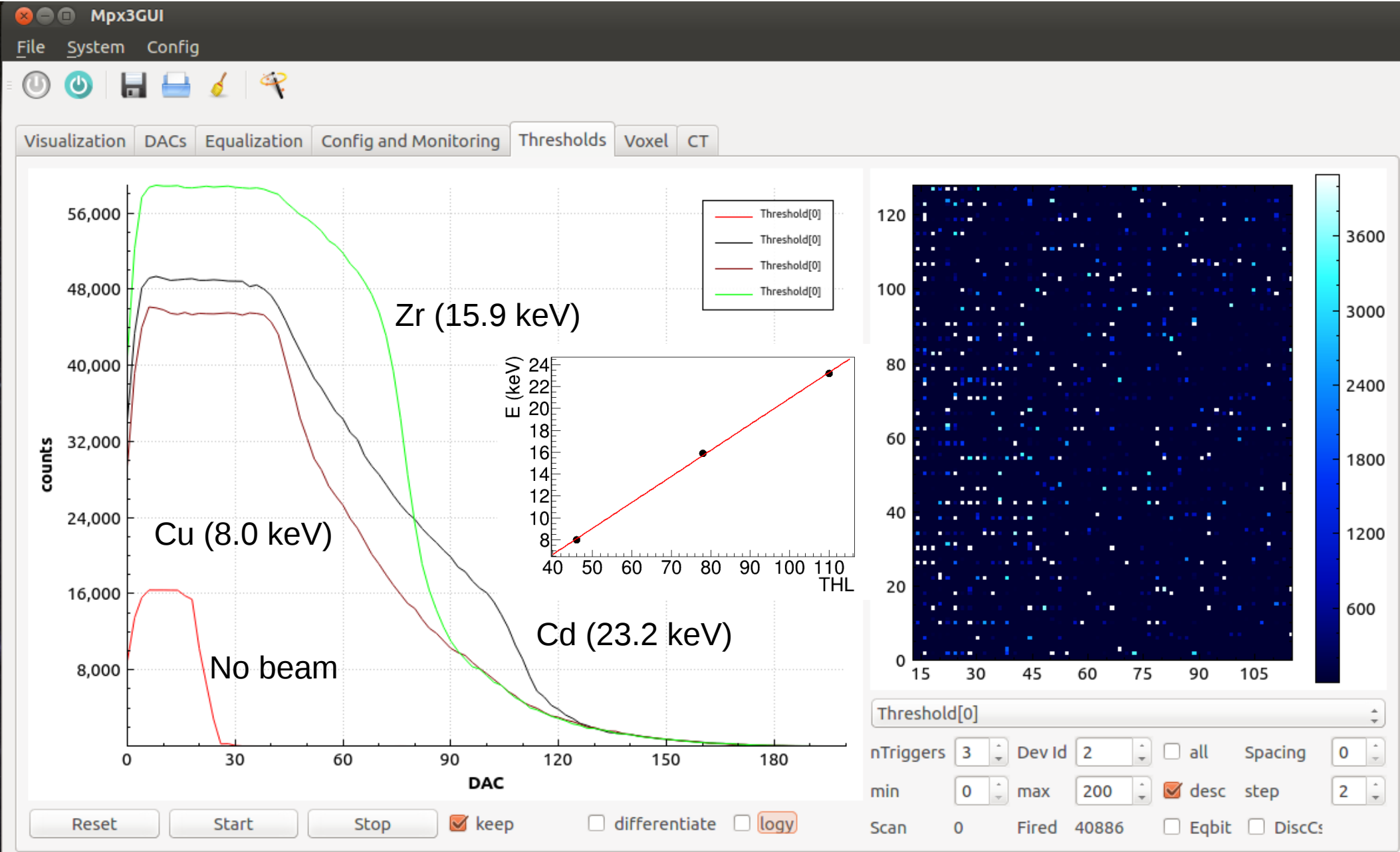
**Single Pixel Mode (SPM)**

Counter depth . . . . .	24 / 12 / 6 / 1-bit in zero-dead-time mode
Maximum count rate . . . . .	2.5 x 10 <sup>6</sup> counts-per-second/pixel
. . . . .	4.55 x 10 <sup>6</sup> counts-per-second/pixel
Energy resolution. . . . .	1.37 keV @ keV (FWHM), 300 μm Si
. . . . .	1.43 keV @ 10 keV (FWHM), 300 μm Si
Electronic noise. . . . .	~80 e <sup>-</sup> rms
Power consumption . . . . .	7.5 μW/pixel / 30 μW/pixel

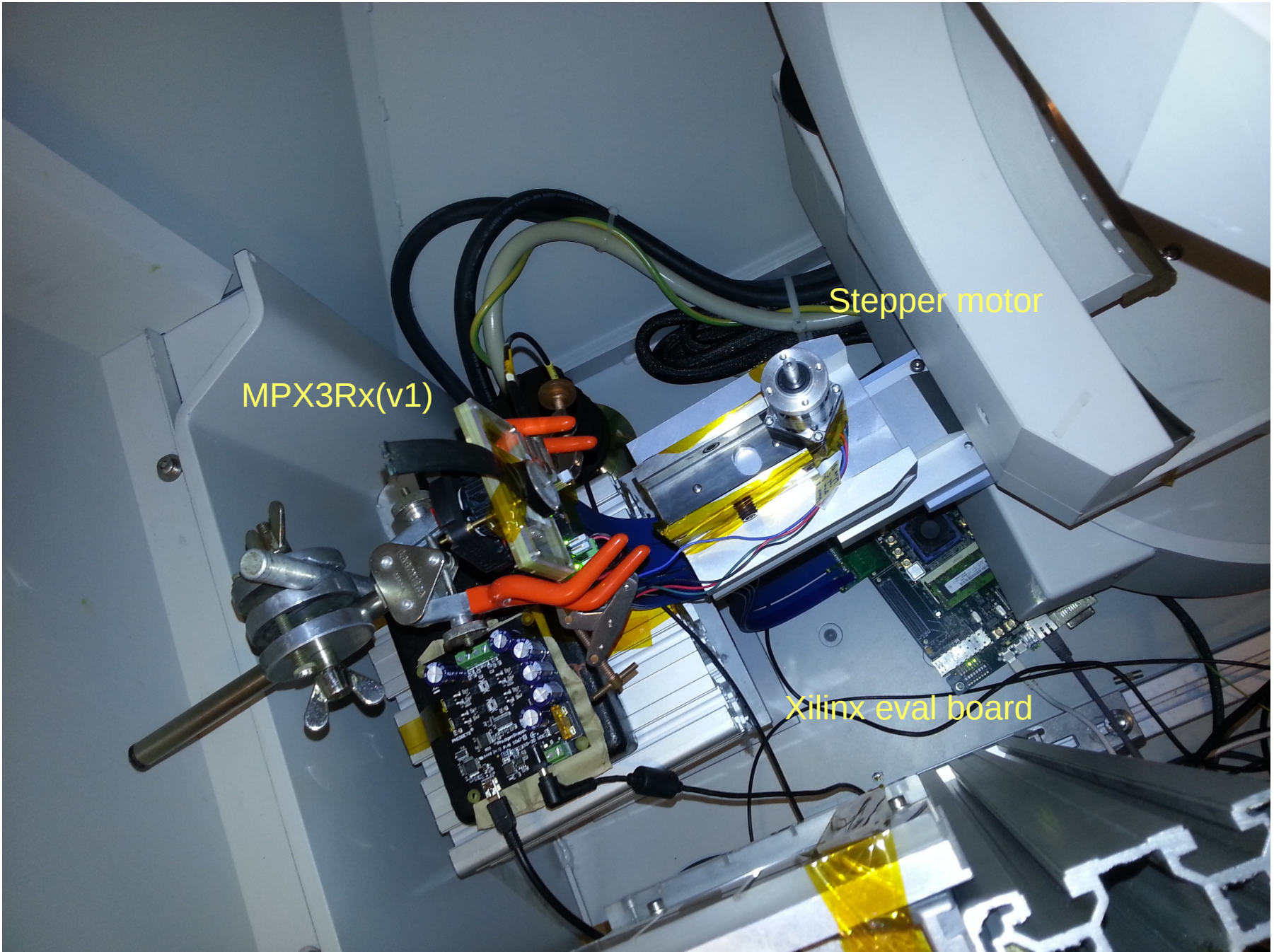
**Charge Summing Mode (CSM)**

Counter depth . . . . .	24 / 12 / 6 / 1-bit in zero-dead-time mode
Maximum count rate . . . . .	0.5 x 10 <sup>6</sup> counts-per-second/pixel
. . . . .	4.55 x 10 <sup>6</sup> counts-per-second/pixel
Energy resolution. . . . .	2.03 keV @ 10 keV (FWHM), 300 μm Si
. . . . .	4.4 keV @ 60 keV (FWHM), 2 mm CdTe
Electronic noise. . . . .	~174 e <sup>-</sup> rms
Power consumption . . . . .	9.3 μW/pixel 37.2 μW/pixel

# Backup slides







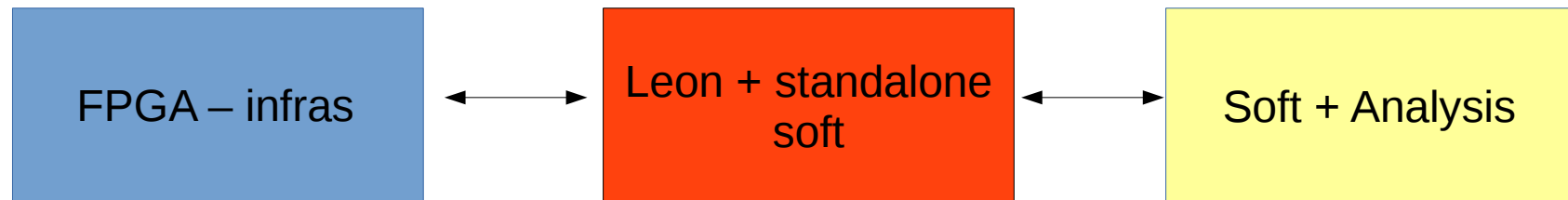
MPX3Rx(v1)

Stepper motor

Xilinx eval board

## Achieved.

- Handshake: Firmware – LEON software – user software.
- The Medipix3RX is working multi-threshold.
- Equalization is ready for both high and low thresholds.
- Software to take and process images is coming together.
- Ready for mammo phantoms and CT.

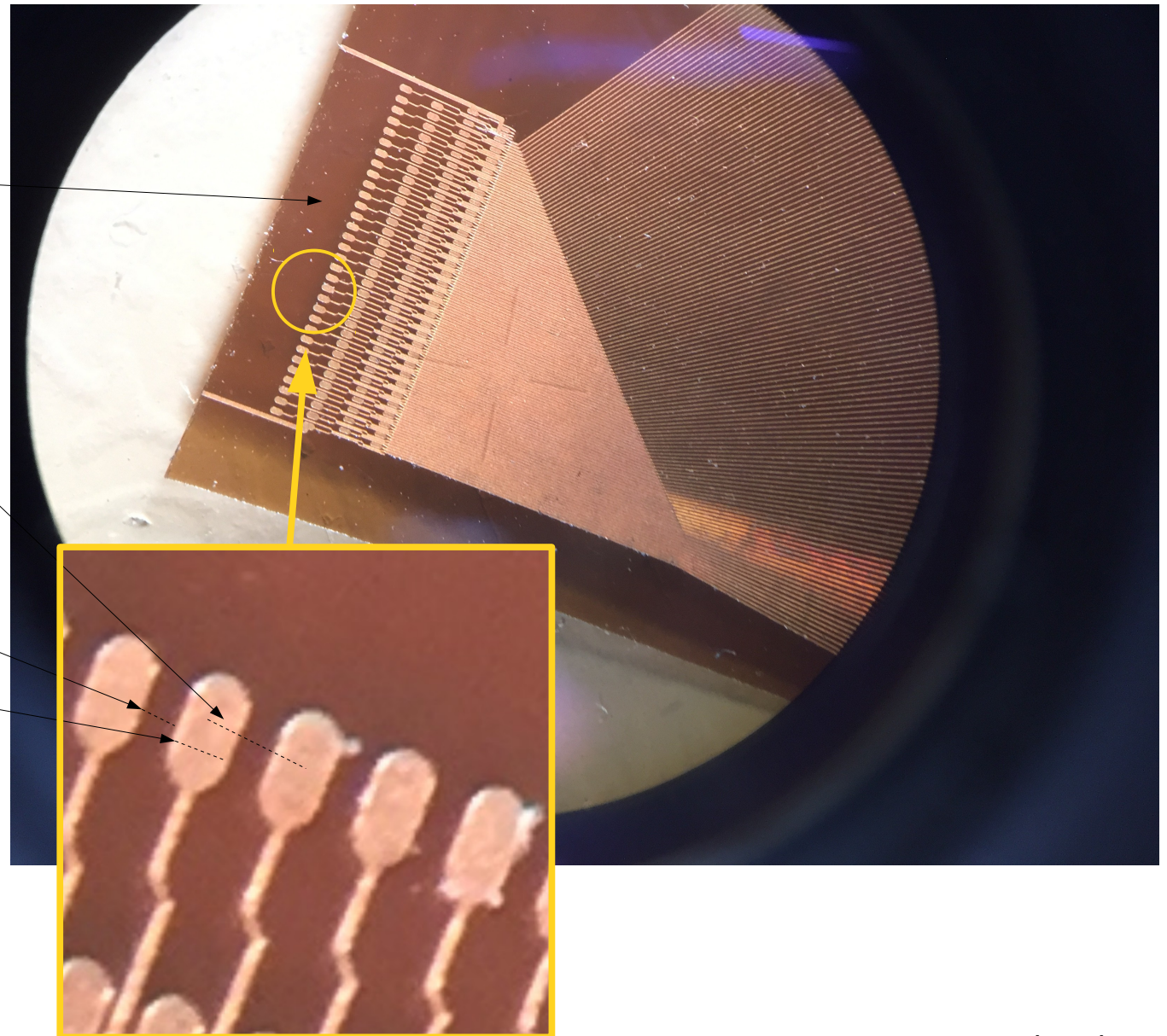


# Resolution – test patterns

32 lines  
Left-most row  
165um pitch

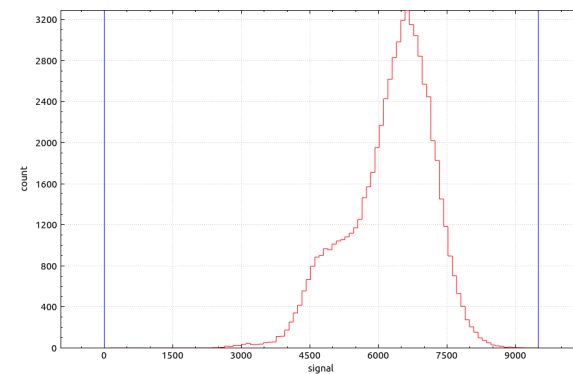
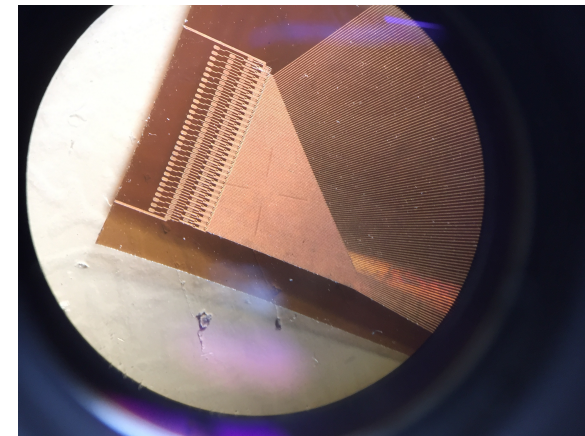
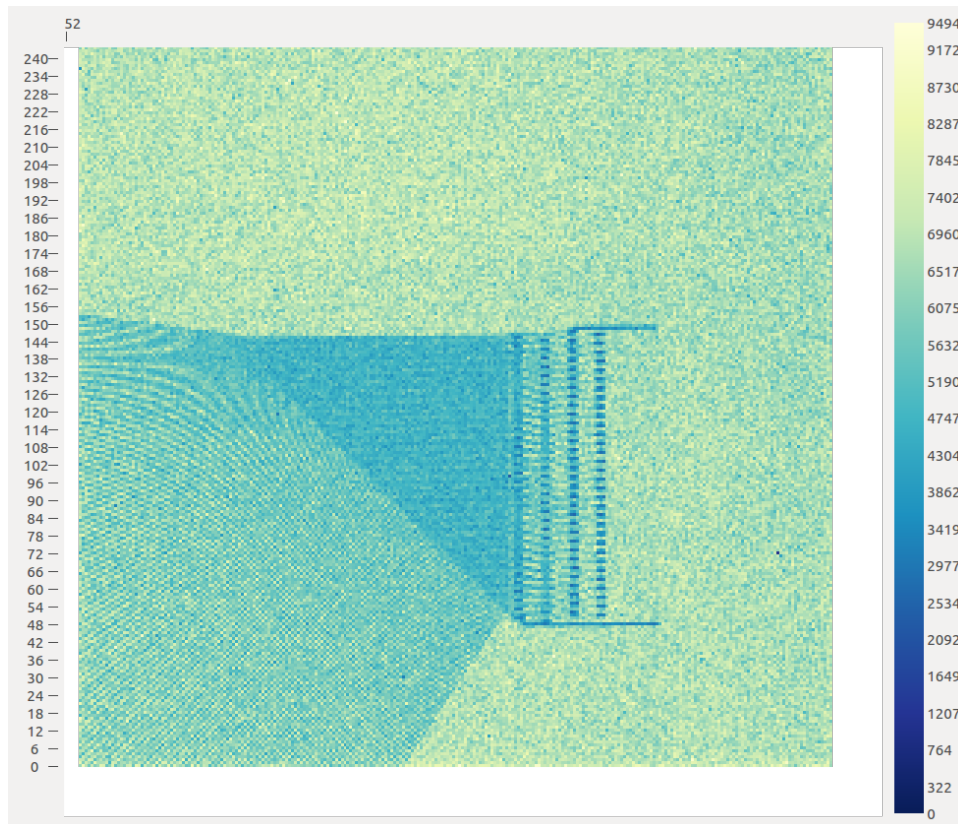
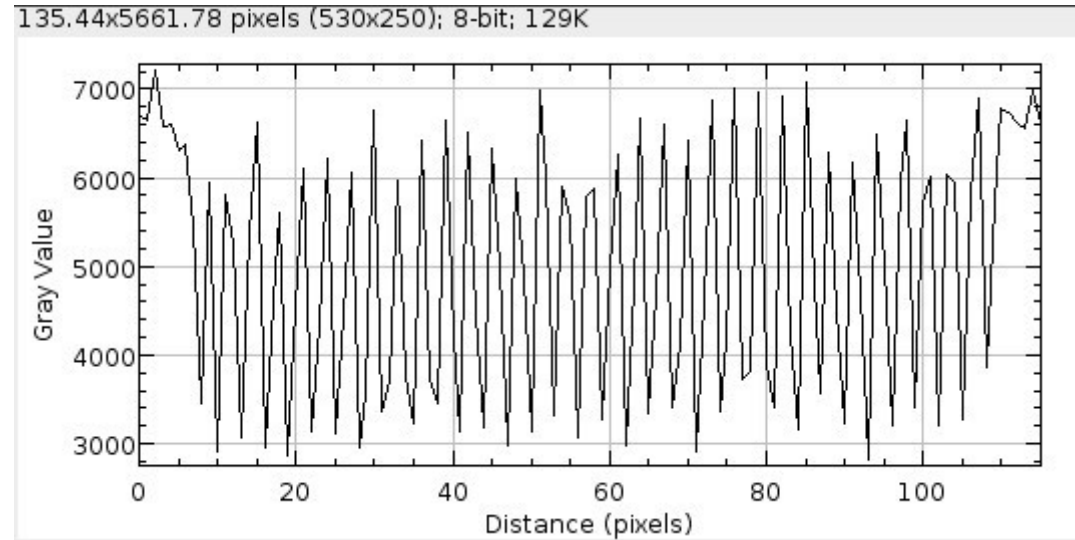
Gap 55um

Pad size 110um



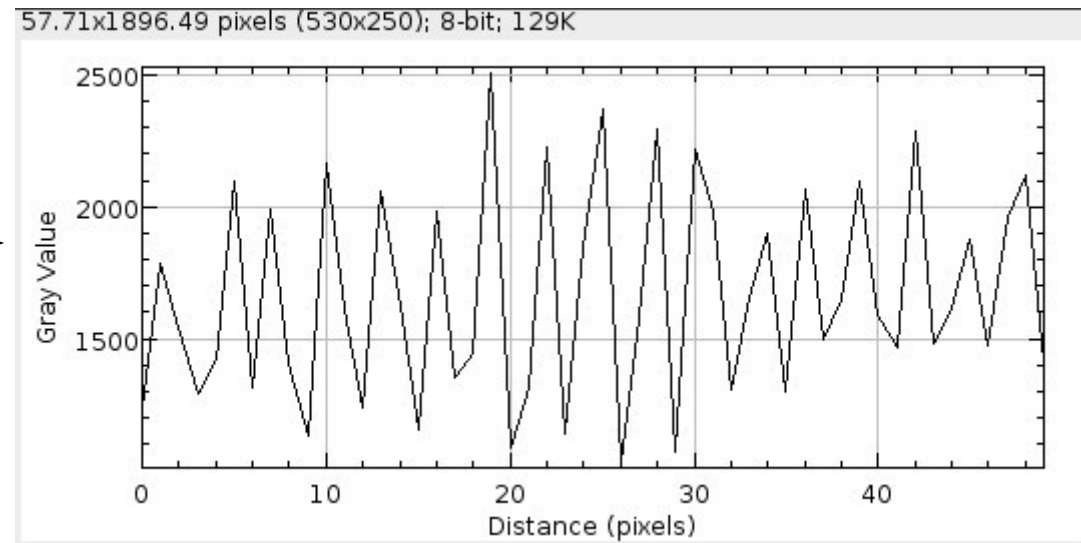
Spatial resolution – Fine pitch - 55um pitch

Correctly resolving the structure  
It is possible to count the lines

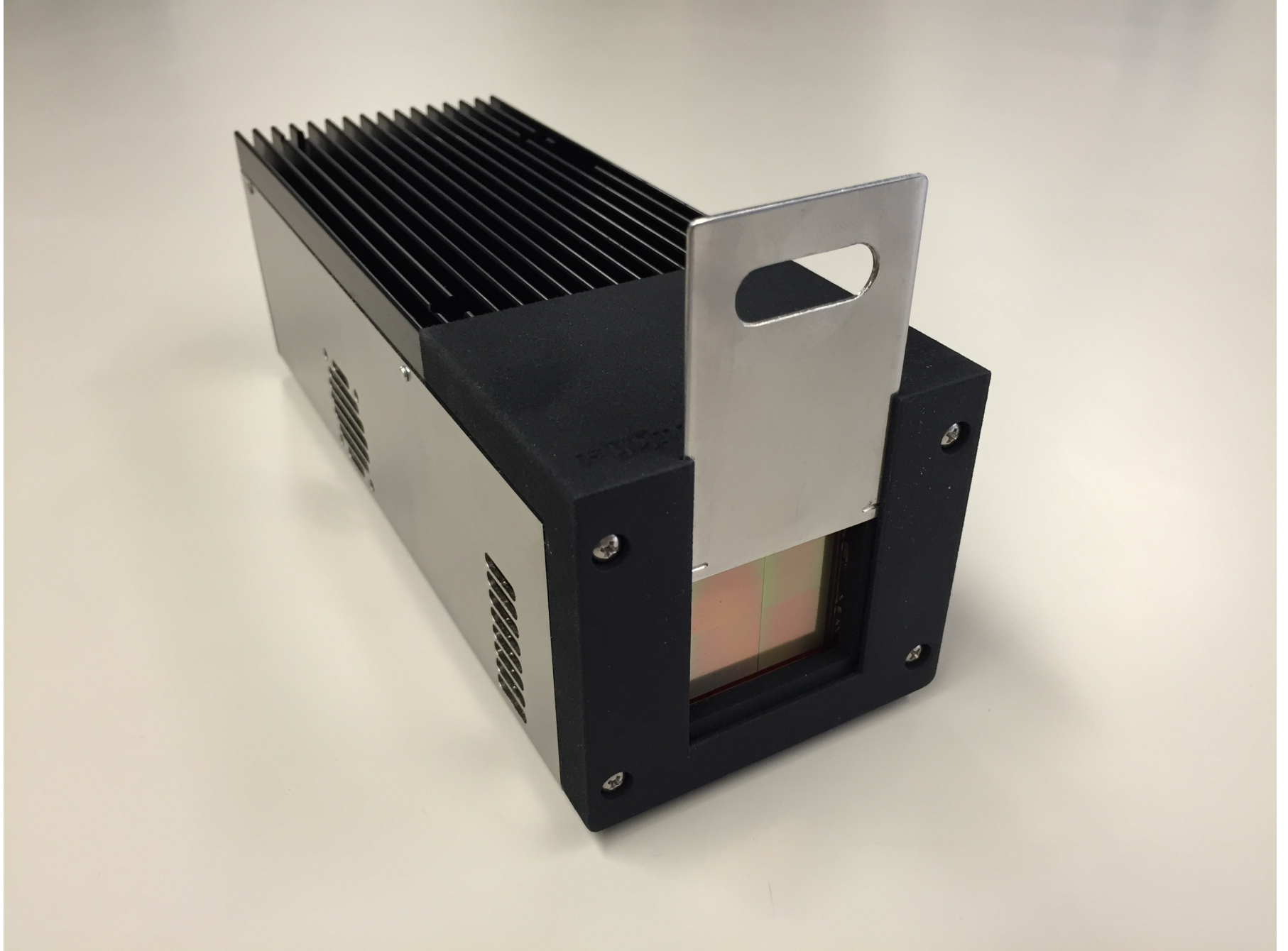


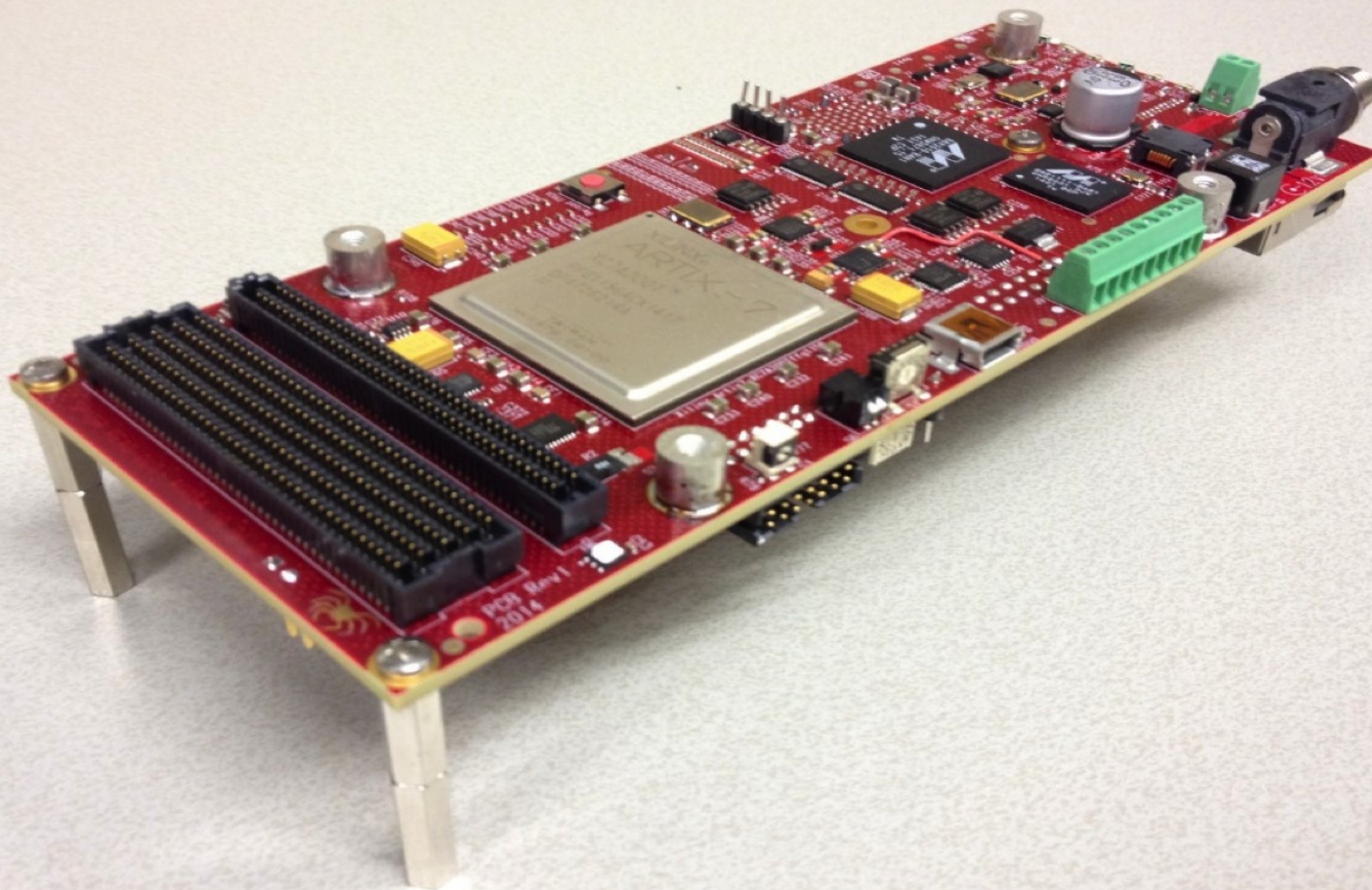
## Spatial resolution – Spectroscopic - 110um pitch

Not able to resolve at 55um pitch

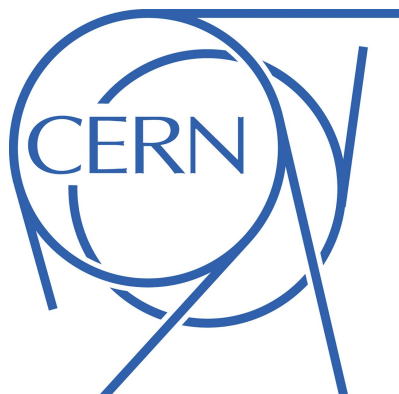


- Need to review and validate the equalization procedure
- Run a complete test with test patterns.
- Calibration of thresholds
- Beam hardening calibration
  - Test the difference between Al and Glass attenuators
- Start the color reconstruction
- CT





# Collaboration





08/14 - Now **Spectral X-ray imaging**

[Amsterdam, Netherlands](#)

Development of spectral imaging for breast cancer screening. Involvement in the development of FPGA-based hardware, micro-controller software and user software including spectral imaging reconstruction algorithms.

[Nikhef - CERN](#)

01/12 - 07/14 **Radiation monitoring for spacecraft**

[Geneva, Switzerland](#)

Involvement in the commissioning of hardware used as radiation monitor in the International Space Station. Assembly and calibration/characterisation work carried out at CERN(Geneva). The detectors were sent to Johnson Space Center and eventually five of them were sent to the International Space Station. I was also involved in the development of the analysis framework and a number of algorithms used in on-line data processing.

[University of Houston - NASA - CERN](#)

09/10 - 02/12 **R&D ATLAS pixel detector**

[Paris-Sud, Orsay](#)

The Large Hadron Collider (LHC) at CERN has four main experiments. The ATLAS detector, being one of them, is scheduled for a number of upgrades all over the 20 years life-span of the detector. I participated in the first upgrade of the pixel detector; called the Insertable b-Layer (IBL). We addressed mostly problems related to radiation damage trying to push the usable life of the detector subsystem to its maximum.

[Laboratoire de l'Accélérateur Linéaire](#)